TPS7A7002EVM-065 Evaluation Module

This user's guide describes operational use of the TPS7A7002EVM-065 evaluation module as a reference design for engineering demonstration and evaluation of the TPS7A7002, a low-dropout linear regulator. Included in this document are setup instructions, a schematic diagram, layout and thermal guidelines, bill of materials and test waveforms.

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1 Introduction

The Texas Instruments TPS7A7002EVM-065 evaluation module (EVM) helps design engineers to evaluate the operation and performance of the TPS7A7002 family of linear regulators for use in their own circuit applications. This particular EVM configuration contains a single linear regulator with internal thermal and current-limit shutdown circuitry in a SOIC-8 package. The regulator is capable of delivering up to 3 A to the load depending on the input/output power dissipation across the part which can be minimized because of the very low-dropout voltage.

2 Setup

This section describes the jumpers and connectors on the EVM as well as how to properly connect, set up, and use the TPS7A7002EVM-065.

2.1 Input/Output Connectors and Jumper Descriptions

The connectors are shown in Figure 3, Assembly Layer.

2.1.1 J1 – VIN

J1 is the input power supply voltage connector. Twist the positive input lead and ground return lead from the input power supply and keep as short as possible to minimize EMI transmission. Add additional bulk capacitance between J1 and J3 if the supply leads are greater than 6 inches. For example, an additional 47-µF electrolytic capacitor connected from J1 to ground can improve the transient response of the TPS7A7002, while eliminating unwanted ringing on the input due to long-wire connections.

2.1.2 J2 – VOUT

J2 is the regulated output voltage connector.

2.1.3 J3 – GND

J3 is the ground-return connector for the input power supply.

2.1.4 J4 – GND

J4 is the output ground-return connector.

2.2 Soldering Guidelines

Any solder rework to modify the EVM for the purpose of repair or other application reasons must be performed using a hot-air system to avoid damaging the integrated circuit (IC).

2.3 Equipment Setup

- Turn off the input power supply after verifying that its output voltage is set to less than 7 V. Connect the positive voltage lead from the input power supply to VIN at the J1 connector of the EVM. Connect the ground lead from the input power supply to GND at the J3 connector of the EVM.
- Connect a 0-A to 3-A load between the output, VOUT, at connector J2, and ground, GND, at connector J4.

3 Operation

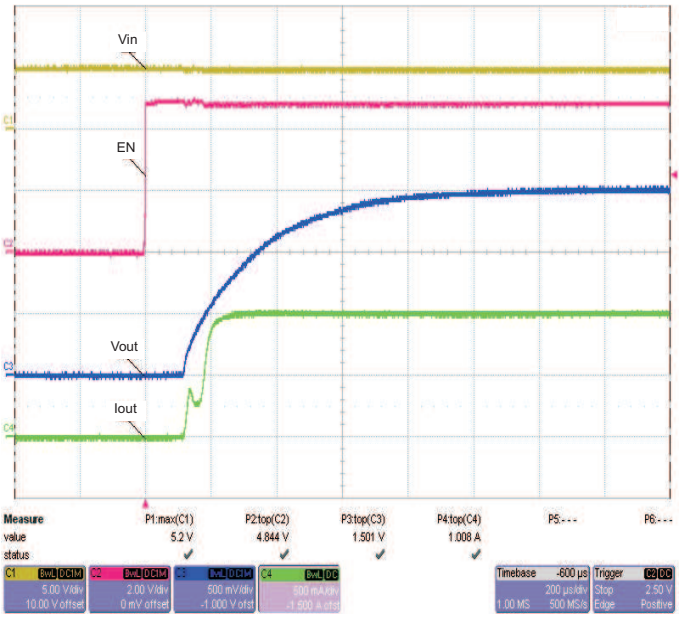
- Turn on the input power supply. For initial operation set the input power supply, VIN – J1, to 5 V.
- Vary the respective loads and VIN voltages as necessary for test purposes.

4 Test Results

This section provides typical performance waveforms for the TPS7A7002EVM-065 printed-circuit board (PCB).

4.1 Turnon Sequence

Figure 1 shows the turnon/off characteristic where 3.3 V is quickly applied to VIN. The output drives a 1-A load. The output voltage start-up ramp is not load dependant.

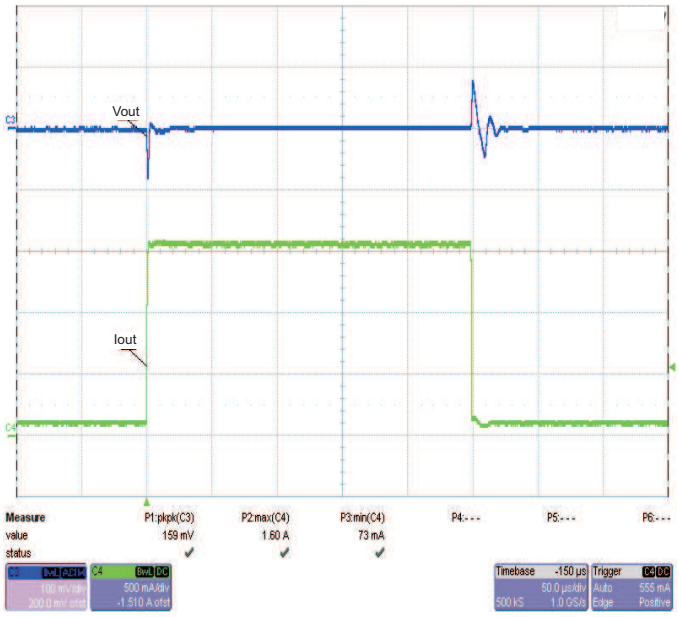


NOTE: Yellow – VIN, Red – EN, Blue – VOUT, Green – IOUT

Figure 1. Turnon Sequence

4.2 Output Load Transient

Figure 2 shows the load transient response for a load-step transient from 100 mA to 1.6 A (IOUT, green). VIN is set at 5 V.



NOTE: Blue – VOUT, Green – IOUT

Figure 2. Load-Step and Transient Response

5 Thermal Guidelines and Layout Recommendations

Thermal management is a key component of design of any power converter and is especially important when the power dissipation in the low-dropout (LDO) regulator is high. Use the following formula to approximate the maximum power dissipation for the particular ambient temperature:

$T_J = T_A + P_D \times \theta_{JA}$

Where T_J is the junction temperature, T_A is the ambient temperature, P_D is the power dissipation in the device (Watts), and θ_{JA} is the thermal resistance from junction to ambient. All temperatures are in degrees Celsius. The maximum silicon junction temperature, T_J, must not be allowed to exceed 150°C. The layout design must use copper trace and plane areas effectively, as thermal sinks, in order not to allow T_J to exceed the absolute maximum rating under all temperature conditions and voltage conditions across the part.

The layout designer must carefully consider the thermal design of the PCB for optimal performance over temperature. For this EVM, Figure 4 shows that the PCB top VOUT plane has six, 6-mil thermal via connections to the bottom-side copper VOUT plane to dissipate heat. The PCB is a two-layer board with 2-oz. copper on top and bottom layers. The DDA package drawing can be found at the Texas Instruments Web site in the product folder for the TPS7A7002 LDO.

Table 1 repeats information from the Dissipation Ratings Table of the TPS7A7002 data sheet for comparison with the thermal resistance, θ_{JA}, calculated for this EVM layout to show the wide variation in thermal resistances for given copper areas. The High-K value is determined using a standard JEDEC High-K (2s2p) board having dimensions of 3-inch x 3-inch with 1-oz internal power and ground planes and 2-oz copper traces on top and bottom of the board.

Table 1. Thermal Resistance, θ_{JA}, and Maximum Power Dissipation

Board	Package	θ_{JA}	Maximum Dissipation Without Derating (T_A = 25°C)	Maximum Dissipation Without Derating (T_A = 70°C)
High-K	DDA	51.5°C/ W	1.94 W	1.06°C/ W
TPS7A7002EVM-065	DDA	23.6°C/ W	4.24 W	2.33 W

6 Board Layout

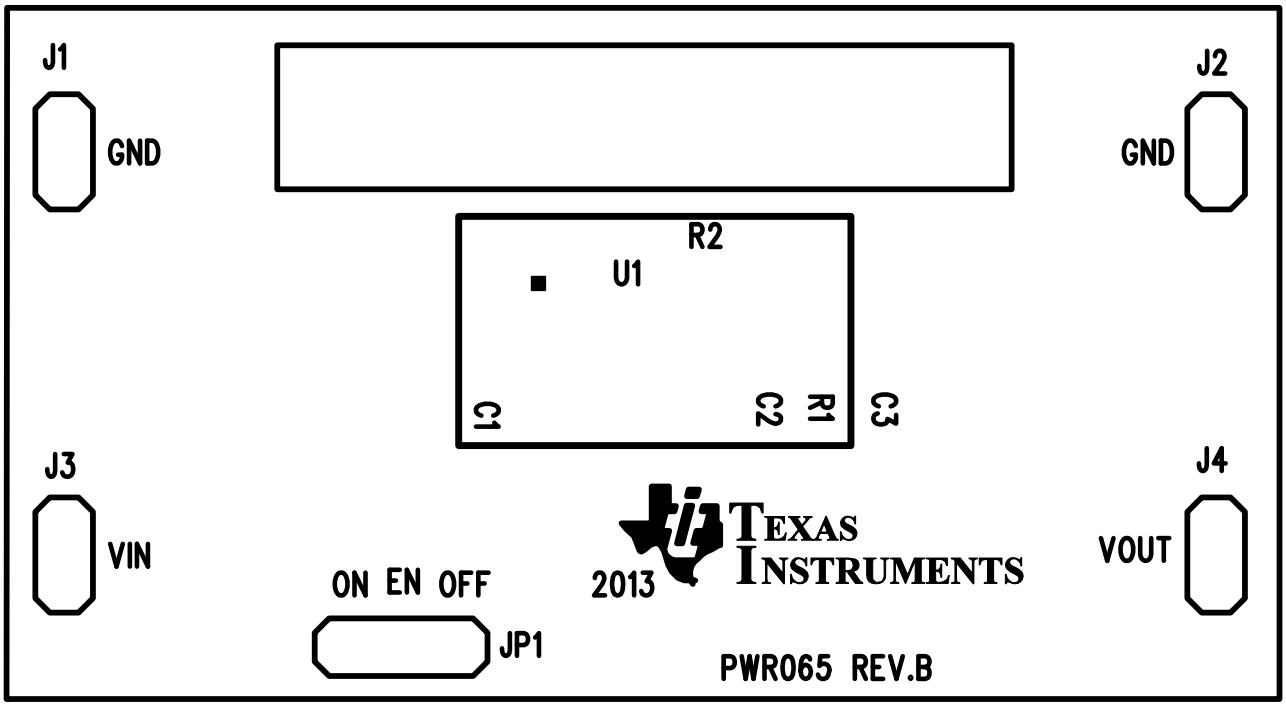


Figure 3. Assembly Layer

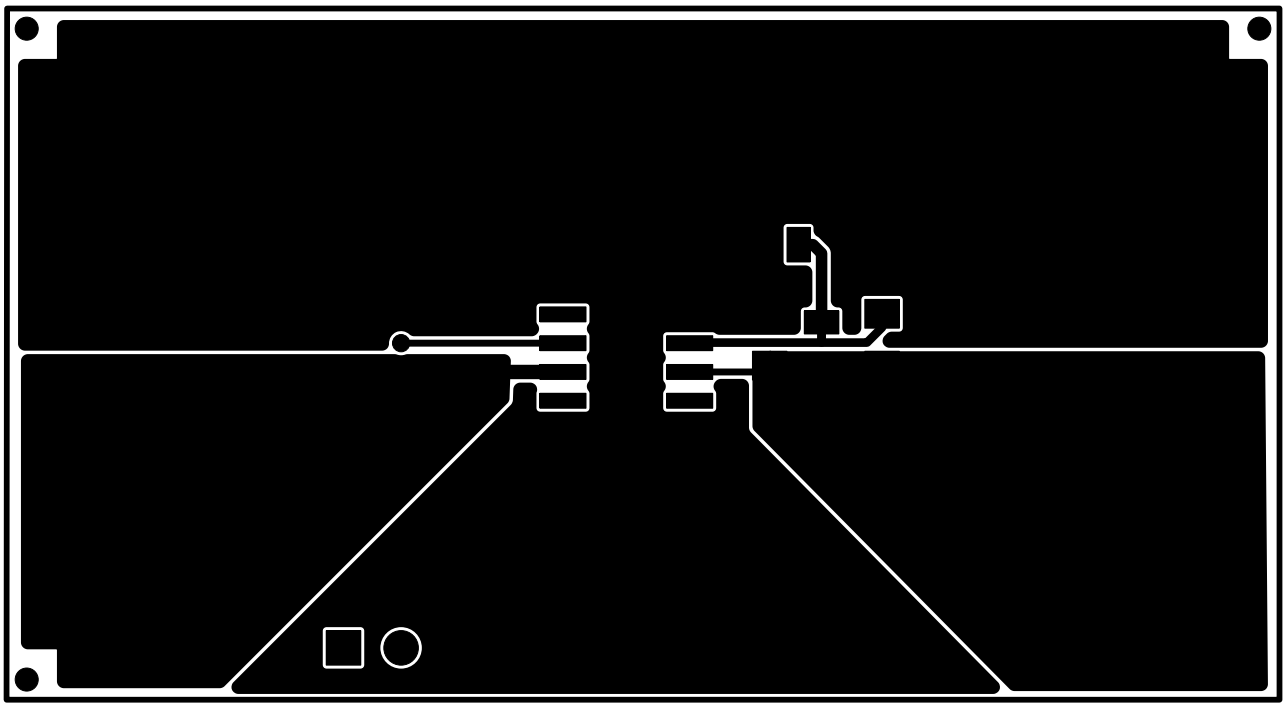


Figure 4. Top-Layer Routing

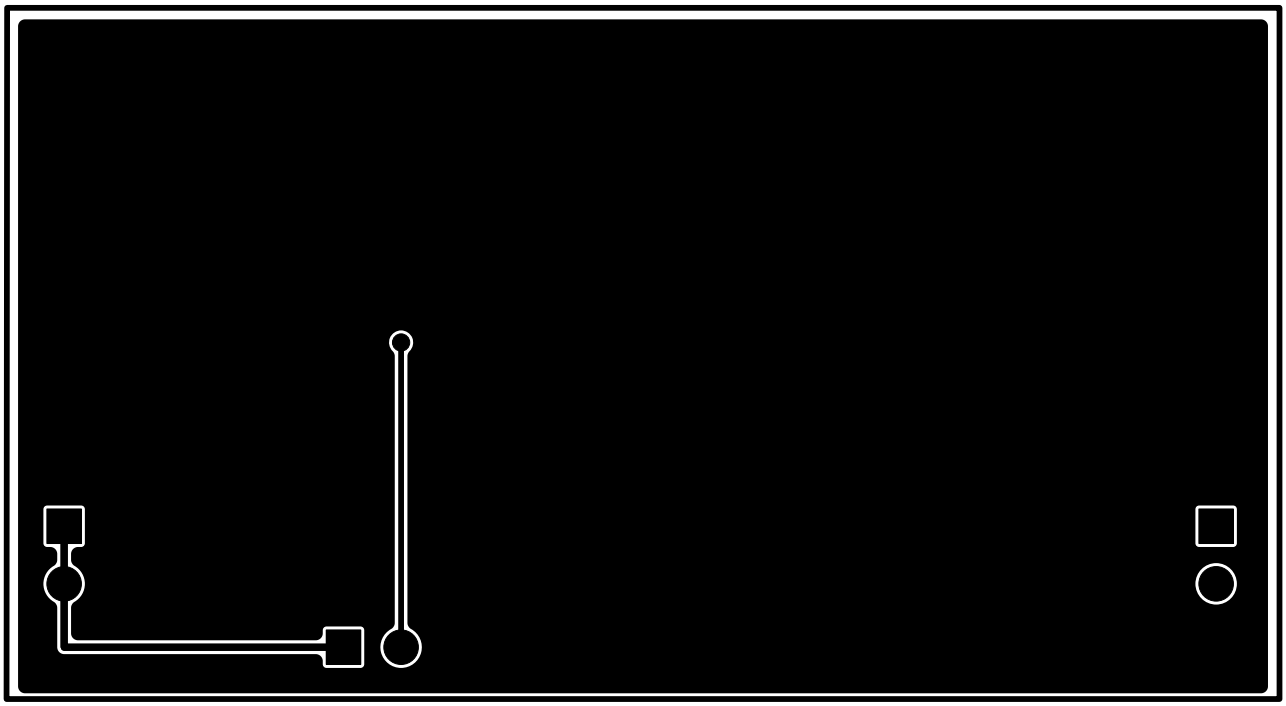
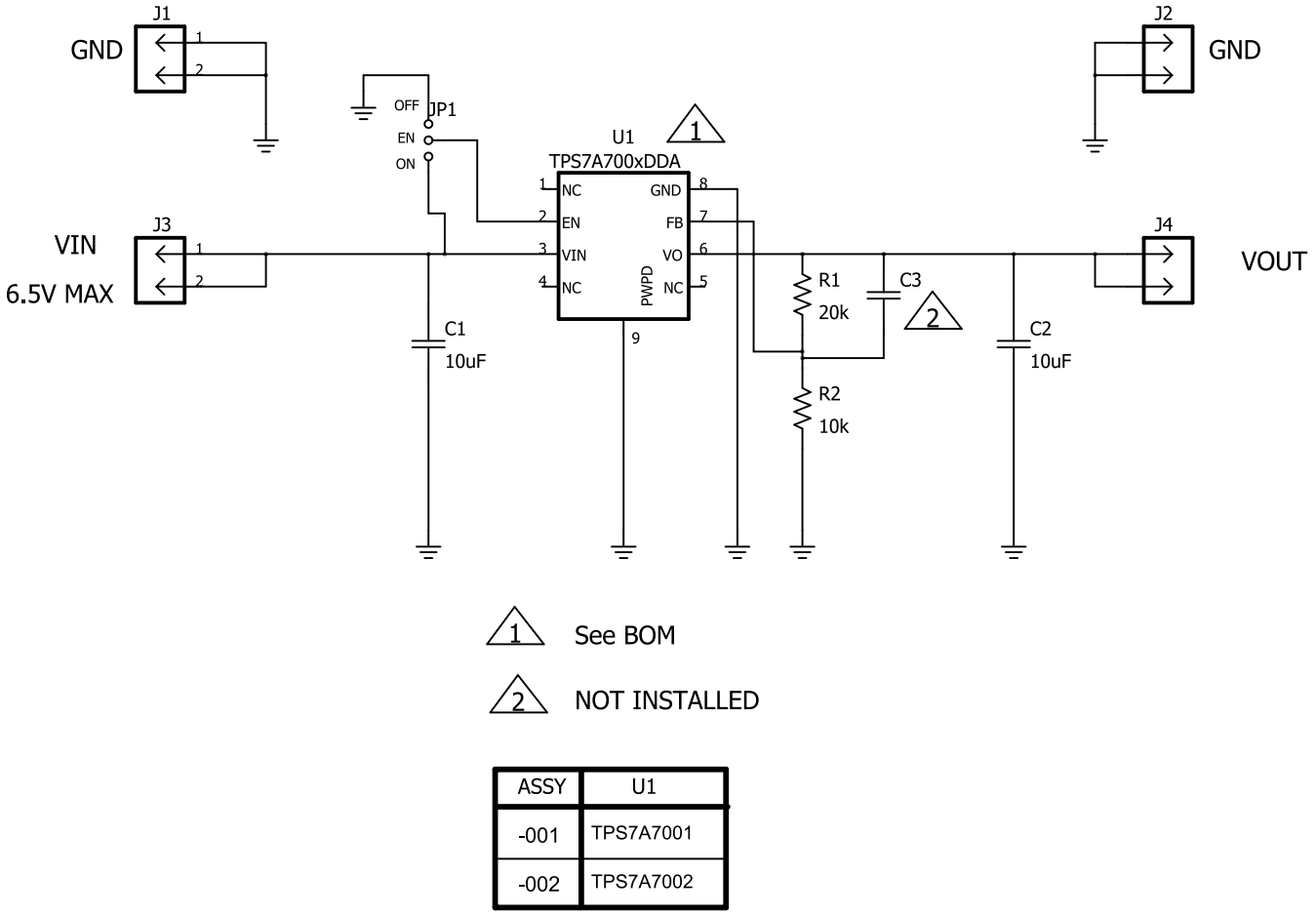


Figure 5. Bottom-Layer Routing

7 Schematic and Bill of Materials

7.1 Schematic



ASSY	U1
-001	TPS7A7001
-002	TPS7A7002

Figure 6. TPS7A7002EVM-065 Schematic

7.2 Bill of Materials

Table 2. TPS7A7002EVM-065 Bill of Materials

Count	RefDes	Value	Description	Size	Part Number	MFR
2	C1-2	10 µF	Capacitor, Ceramic, 10-V, X7R, 10%	0805	STD	STD
0	C3	Open	Capacitor, Ceramic, 10-V, X7R, 10%	0805	STD	STD
4	J1-4	PEC02SAAN	Header, Male 2-pin, 100-mil spacing	0.100 inch x 2	STD	Sullins
1	JP1	PEC03SAAN	Header, Male 3-pin, 100-mil spacing	0.100 inch x 3	STD	Sullins
1	R1	20 kΩ	Resistor, Chip, 1/16-W, 1%	0603	STD	STD
1	R2	10 kΩ	Resistor, Chip, 1/16-W, 1%	0603	STD	STD
1	U1	TPS7A7002DDA	IC, Wide Vin, Very Low-Dropout Regulator	HSOP	TPS7A7002DDA	TI
1	—		PCB, 1.200 In x 2.200 In x 0.62 In	1.20 x 2.200 x 0.62 In	PWR065	Any

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For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

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This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

For EVMs annotated as IC – INDUSTRY CANADA Compliant

This Class A or B digital apparatus complies with Canadian ICES-003.

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Concerning EVMs including radio transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs including detachable antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

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Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

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Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

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2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

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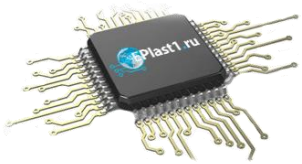
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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